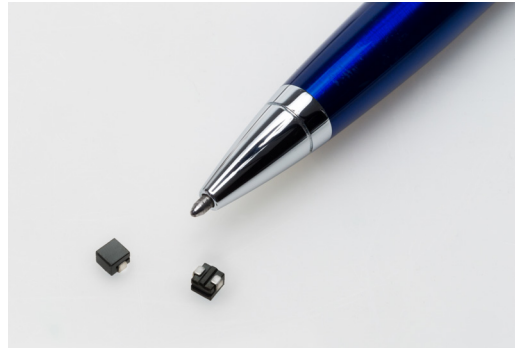


# FP0404

## High frequency, high current power inductors



### Product features

- High current carrying capacity
- Low core loss
- DC-DC converter applications up to 2 MHz
- Filtering applications see inductance vs frequency and impedance vs frequency curves on page 5
- Inductance Range from 22 nH to 170 nH
- Current range up to 40 A
- 4.0 mm x 4.0 mm footprint surface mount package in 3.0 mm and 4.0 mm heights
- Moisture sensitivity level (MSL): 1
- Ferrite core material

### Applications

- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
- Server and desktop VRMs and EVRDs
- Laptop and notebook regulators
- Data networking and storage systems
- Graphics cards and battery power systems
- Point-of-Load modules

### Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant



**Product specifications**

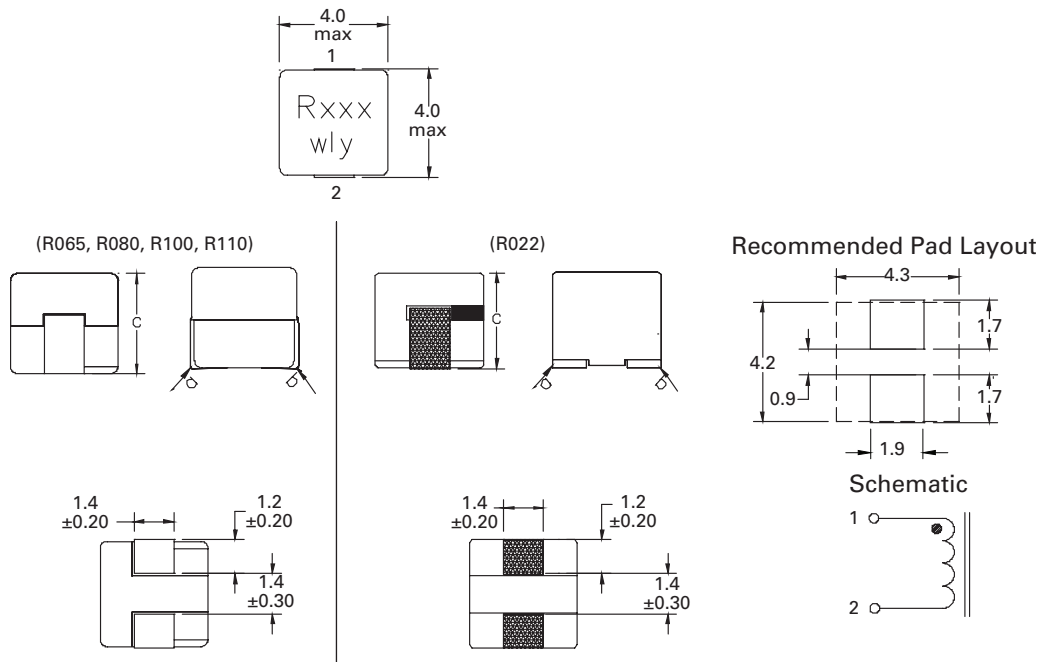
Part number <sup>5</sup>	OCL <sup>1</sup> (nH) ±15%	FLL <sup>2</sup> (nH) minimum	I <sub>RM</sub> <sup>3</sup> (A)	I <sub>RM</sub> <sup>14</sup> (A)	I <sub>RM</sub> <sup>25</sup> (A)	I <sub>RM</sub> <sup>36</sup> (A)	DCR (mΩ) @ +20 °C ±25%	K-factor <sup>7</sup>
FP0404R1-R022-R	22 ±20%	15	40	40	34	32	0.32 ± 15%	2351
FP0404R1-R065-R	65	44	40	24	22	20	0.32	2248
FP0404R1-R080-R	80	54	40	19.5	18	16	0.32	2248
FP0404R1-R100-R	100	68	40	15.6	14	13	0.32	2248
FP0404R1-R110-R	110	74.5	40	14.2	13	11.8	0.32	2248
FP0404R1-R170-R	170	116	40	9.0	7.8	7.6	0.32	2248

- Open Circuit Inductance (OCL) Test parameters: 100 kHz (1 MHz for R022), 0.1 Vrms, 0.0 Adc, +25 °C
- Full Load Inductance (FLL) Test parameters: 100 kHz (1 MHz for R022), 0.1 Vrms, I<sub>RM</sub><sup>1</sup>, +25 °C
- I<sub>RM</sub>: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 °C underworst case operating conditions verified in the end application.

- I<sub>RM</sub><sup>1</sup>: Peak current for approximately 20% rolloff @ +25 °C
- I<sub>RM</sub><sup>2</sup>: Peak current for approximately 20% rolloff @ +100 °C
- I<sub>RM</sub><sup>3</sup>: Peak current for approximately 20% rolloff @ +125 °C
- K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K \* L \* ΔI \* 10<sup>-3</sup>. Bp-p:(Gauss), K: (K-factor from table), L: (Inductance in nH), ΔI (Peak to peak ripple current in Amps).
- Part Number Definition: FP0404Rx-Rxxx-R  
FP0404 = Product code and size  
Rx= DCR indicator  
Rxxx=Inductance value in μH, R=decimal point  
-R suffix = RoHS compliant

**Dimensions (mm)**

Part number	C max
R022-R	3.0
R065-R	4.0
R080-R	4.0
R100-R	4.0
R110-R	4.0
R170-R	4.0

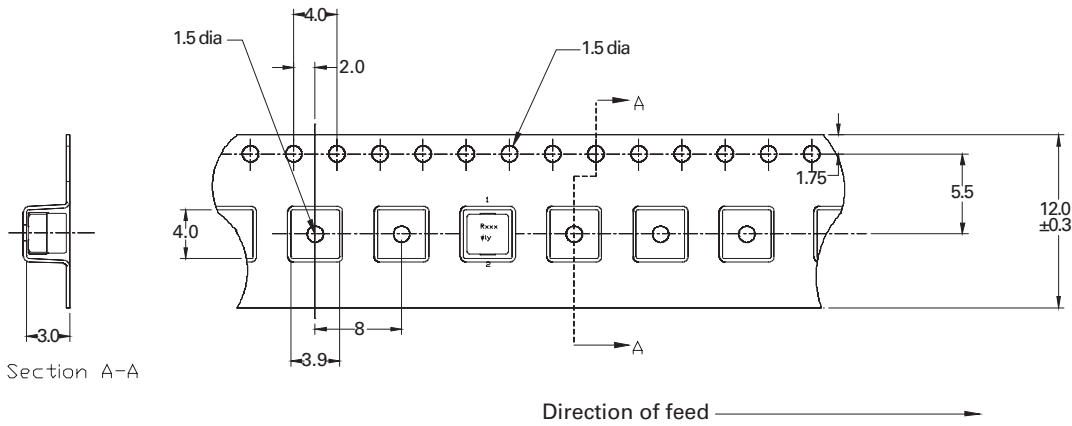


Part marking: Rxxx xxx=inductance value in μH, R=decimal point, wly= date code  
All soldering surfaces to be coplanar within 0.1 millimeters  
DCR is measured from point "a" to point "b"  
Do not route traces or vias underneath the inductor

**Packaging information (mm)**

**FP0404R1-R022-R**

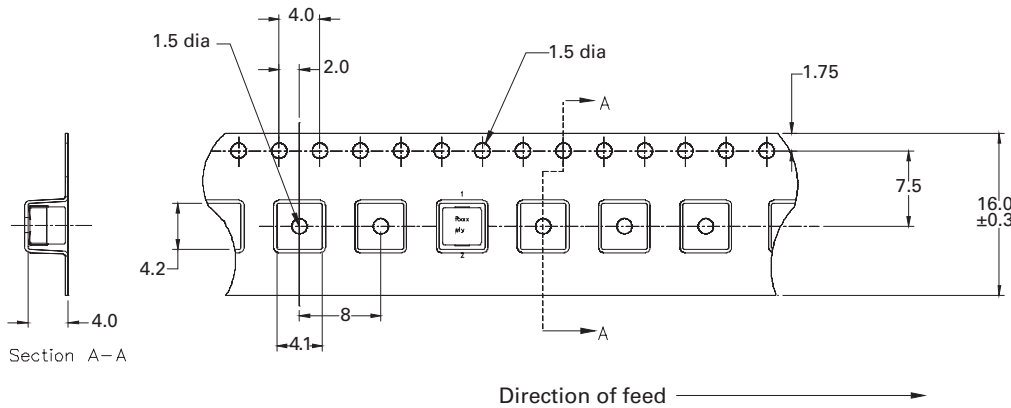
Supplied in tape and reel packaging, 1,800 parts per 13" diameter reel



**Packaging information (mm)**

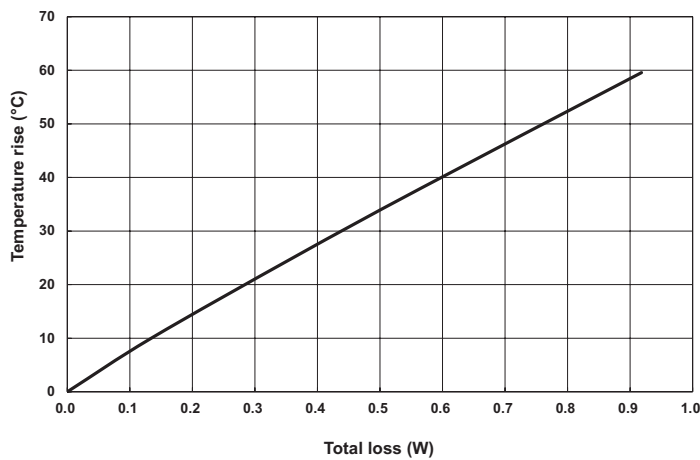
**FP0404R1-R065-R, R080-R, R100-R, R110-R, R-170**

Supplied in tape and reel packaging, 1,800 parts per 13" diameter reel

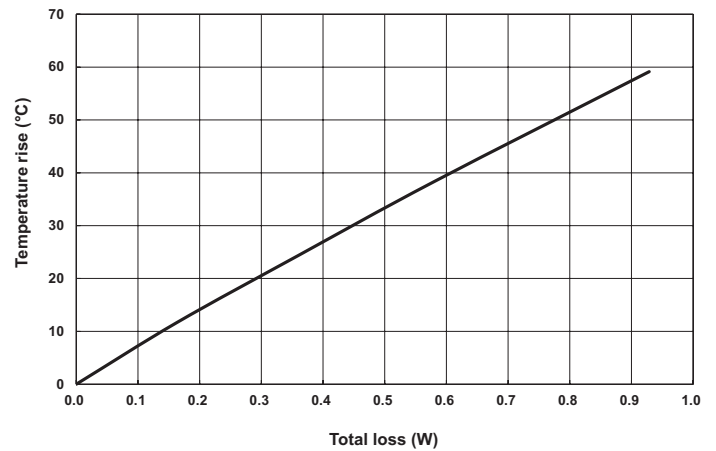


**Temperature rise vs. total loss**

FP0404R1-R022-R

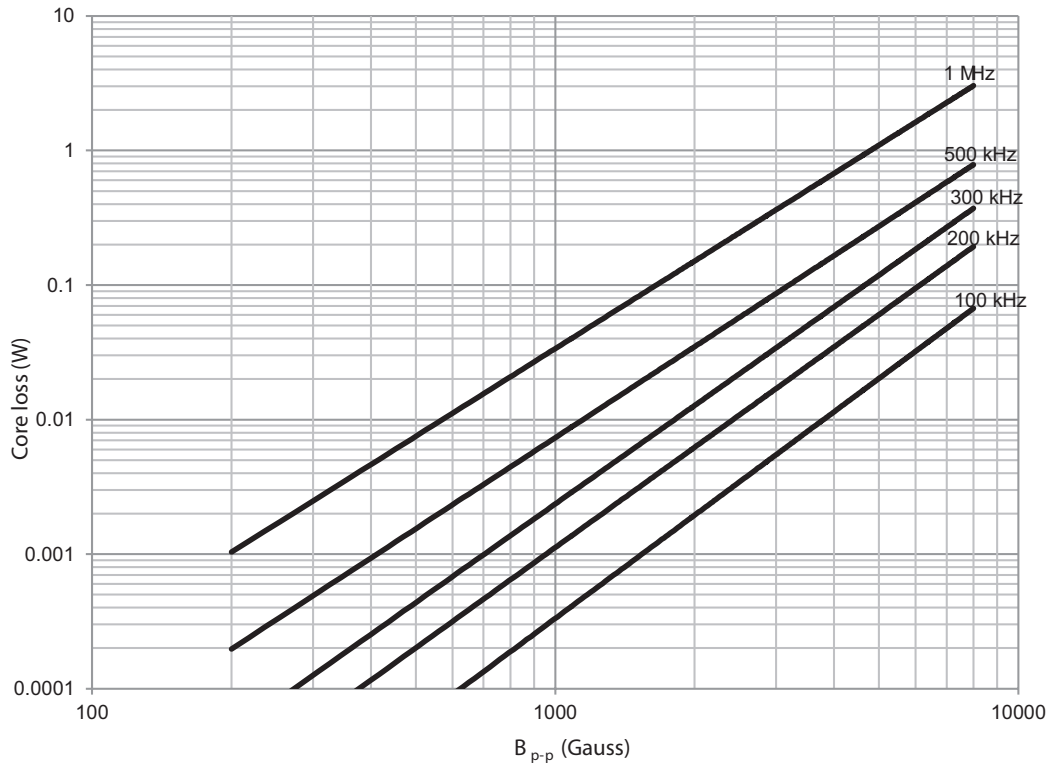


FP0404R1-R065-R, R080-R, R100-R, R110-R, R170

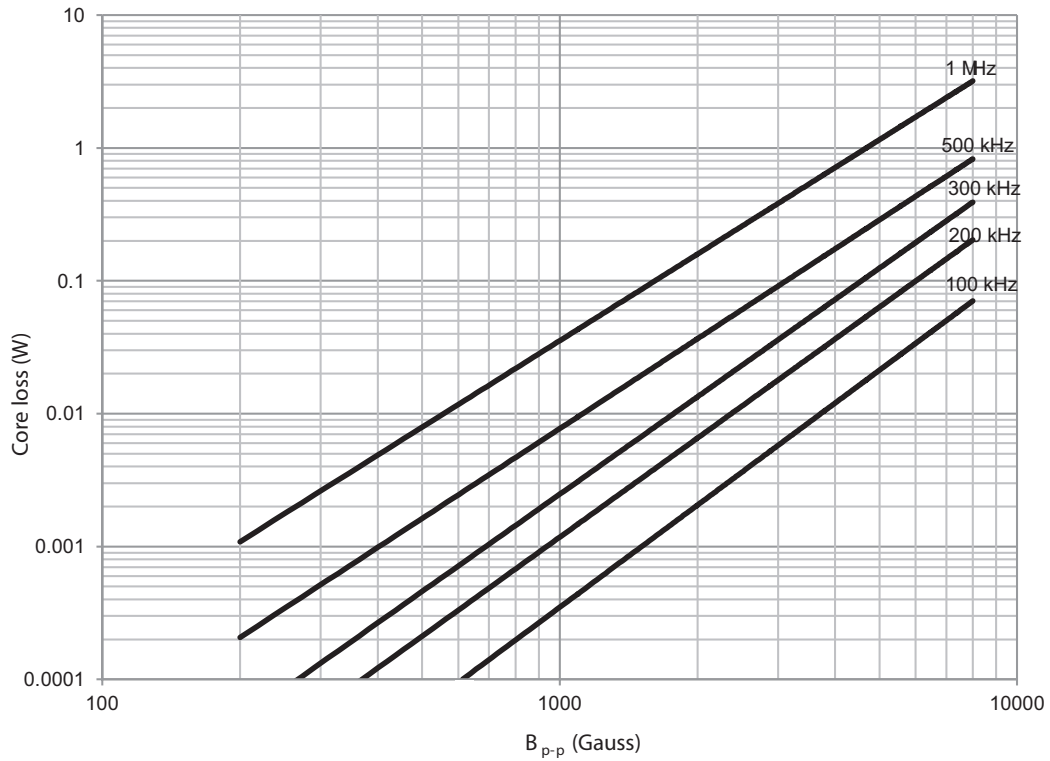


**Core loss vs B<sub>p-p</sub>**

**FP0404R1-R022-R**

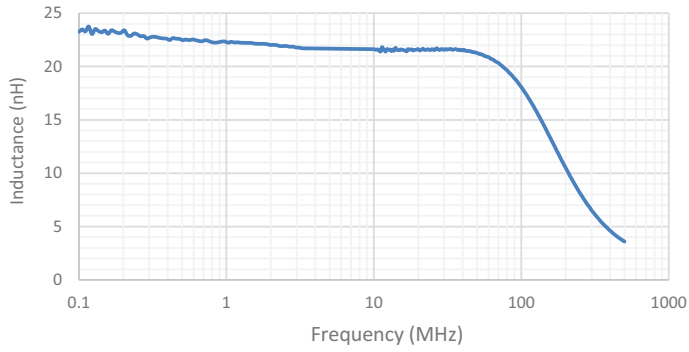


**FP0404R1-R065-R, R080-R, R100-R, R110-R, R-170**

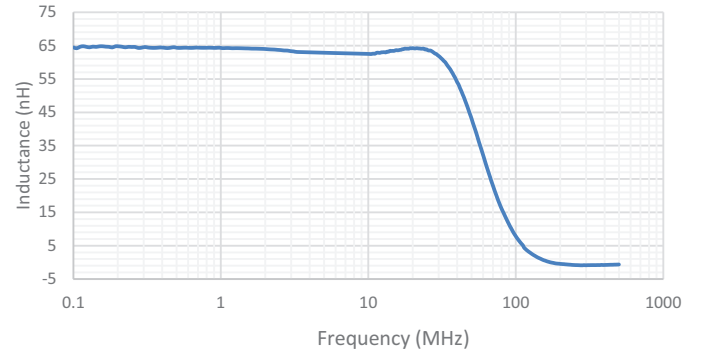


Inductance vs frequency

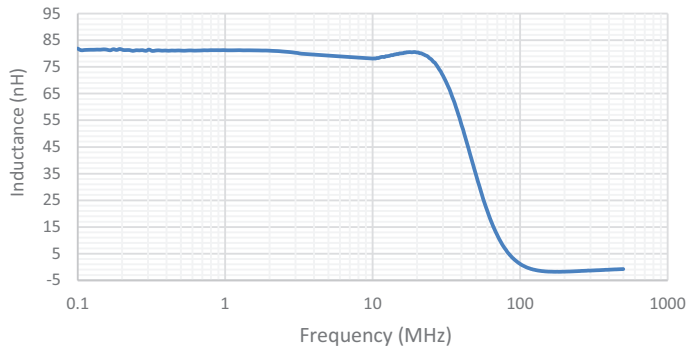
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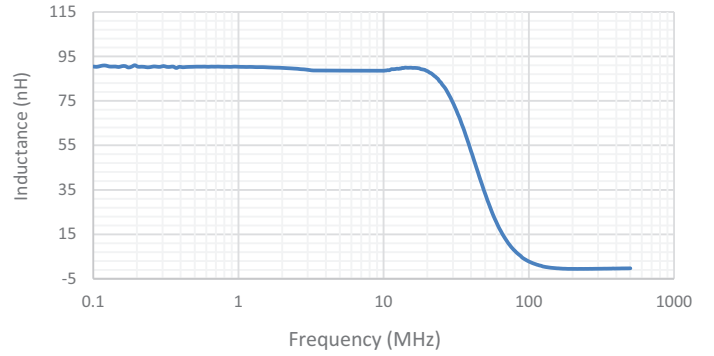
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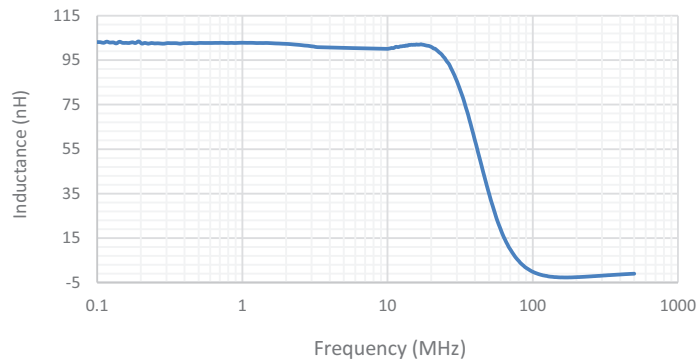
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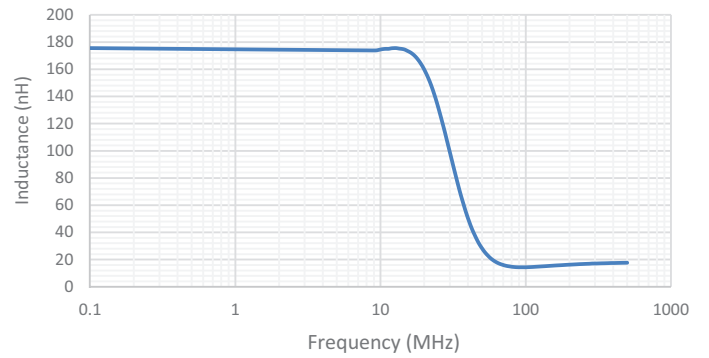
FP0404R1-R100-R



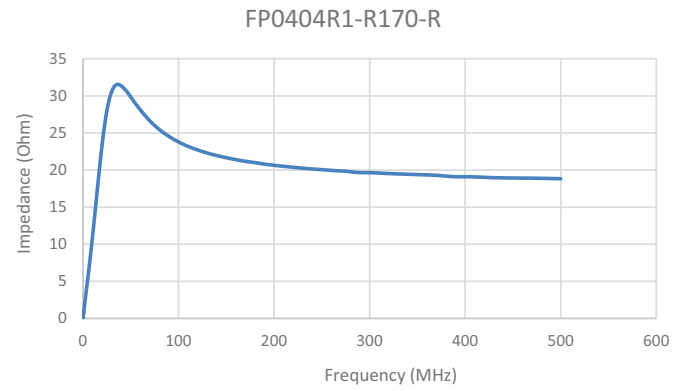
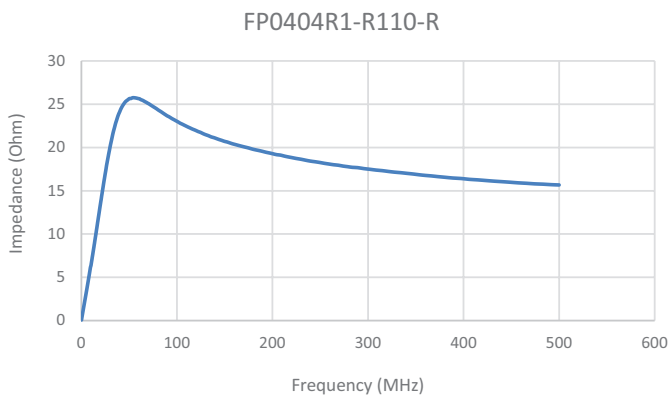
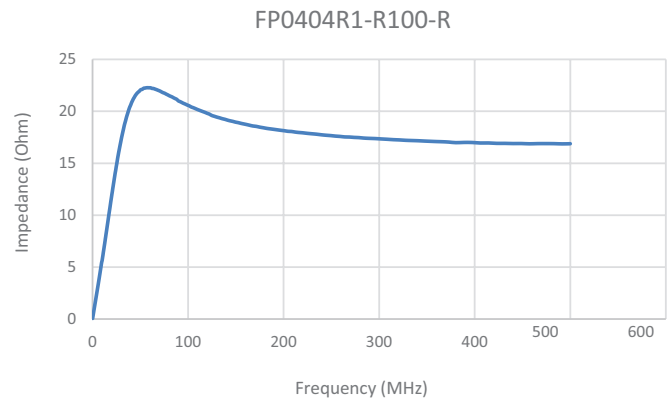
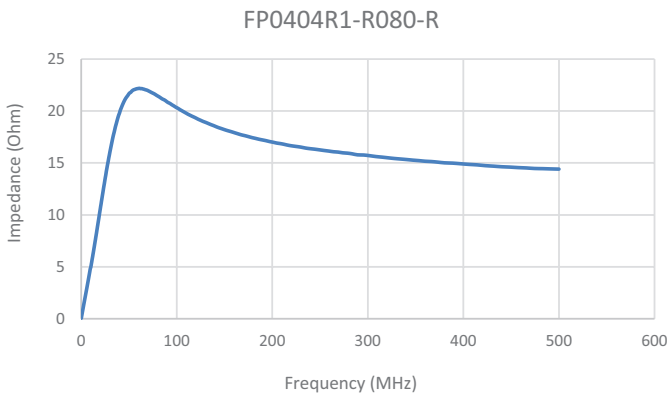
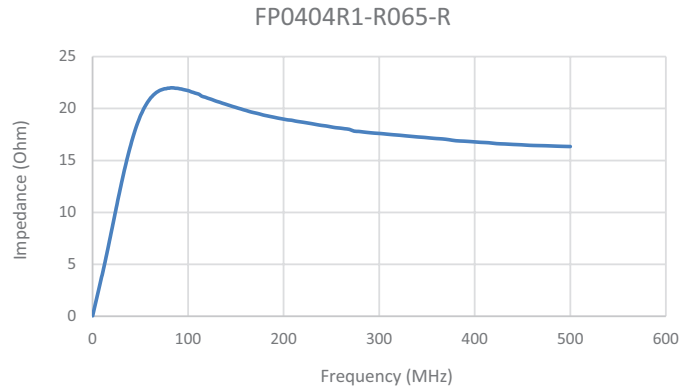
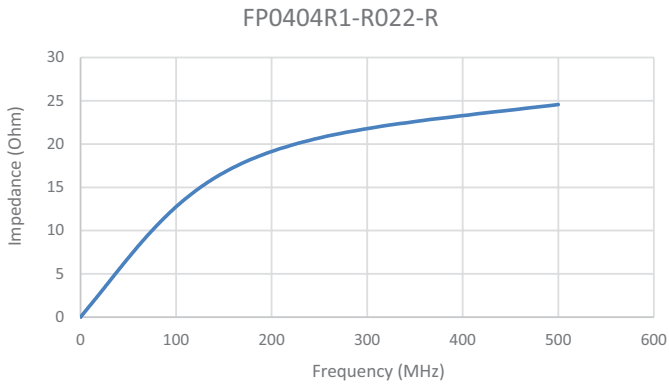
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FP0404R1-R0170-R

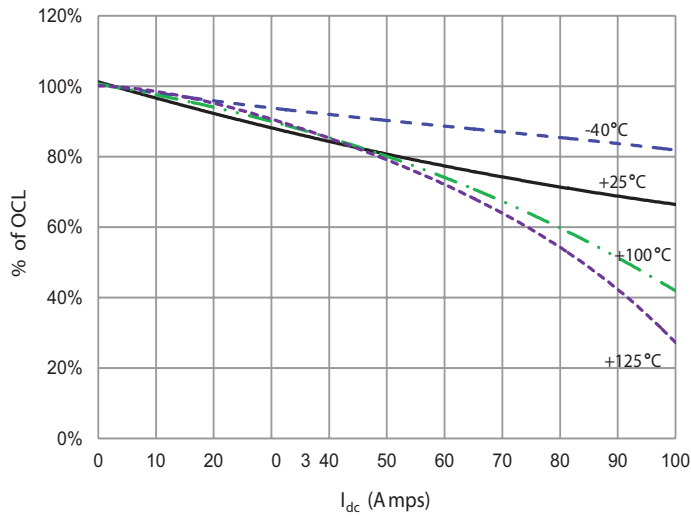


Impedance vs frequency

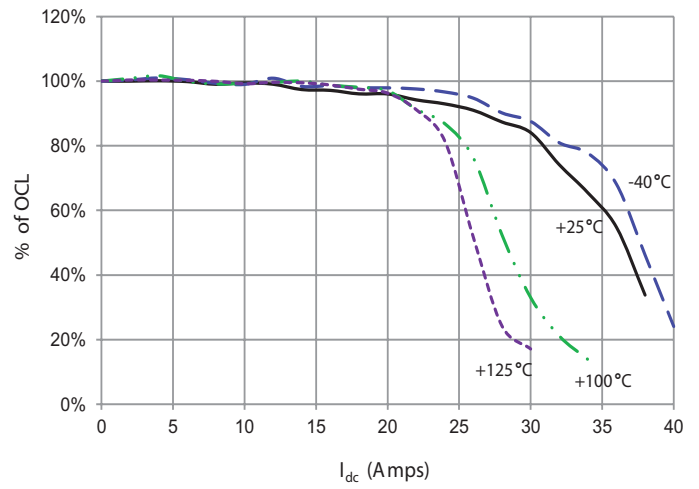


Inductance characteristics

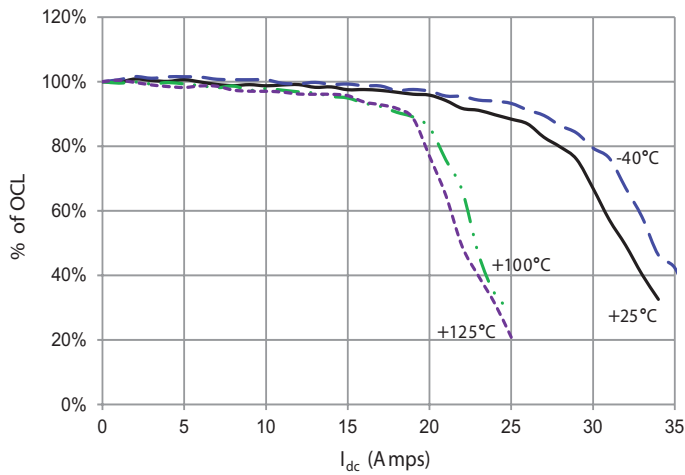
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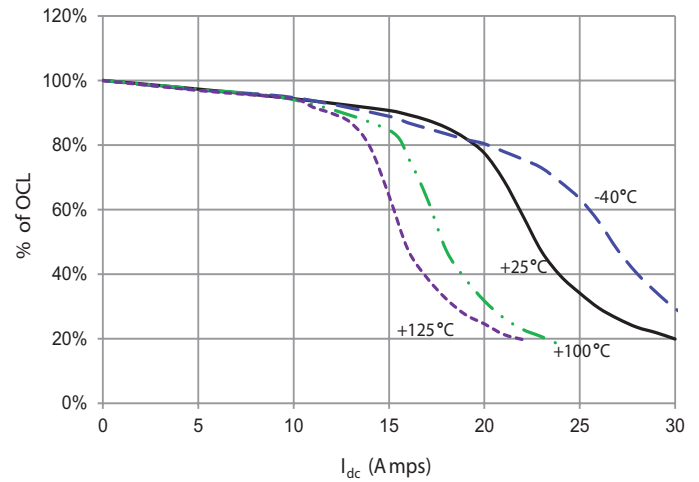
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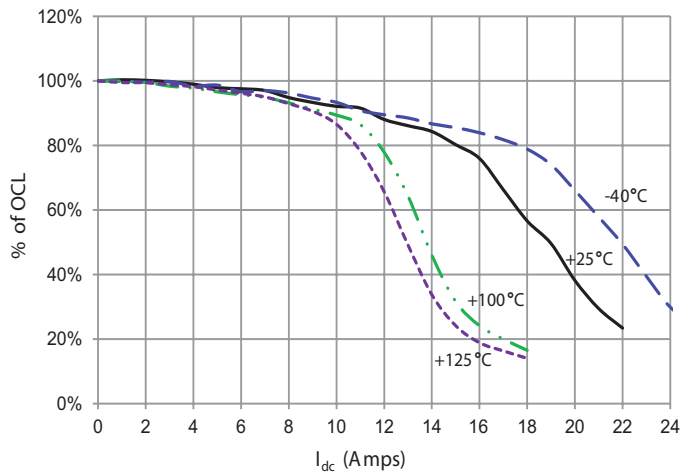
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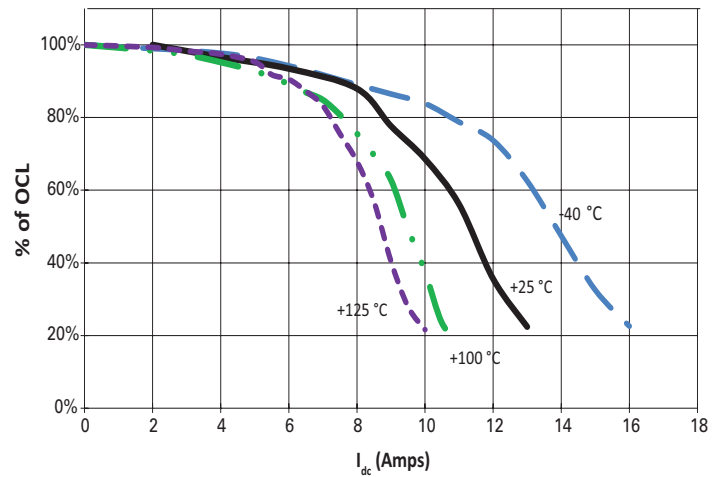
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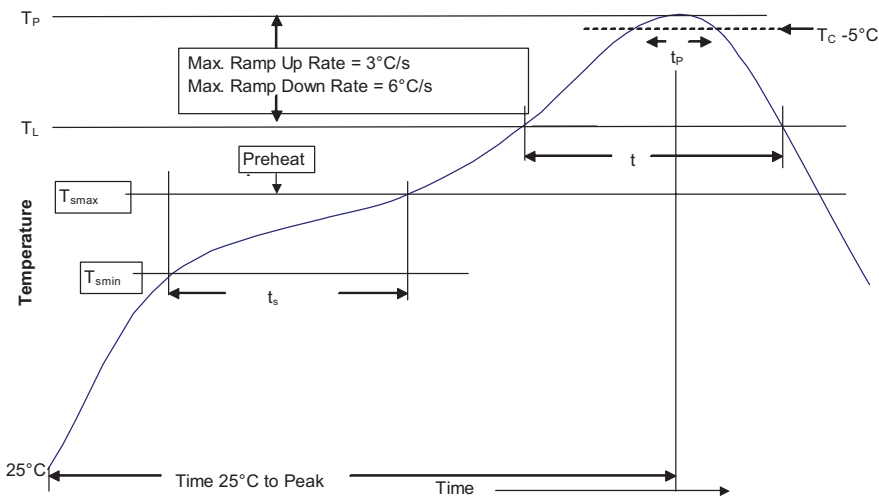
FP0404R1-R110-R



FP0404R1-R170-R



**Solder reflow profile**



**Table 1 - Standard SnPb solder (T<sub>c</sub>)**

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

**Table 2 - Lead (Pb) free solder (T<sub>c</sub>)**

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

**Reference JDEC J-STD-020**

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak	<ul style="list-style-type: none"> <li>Temperature min. (T<sub>smin</sub>) 100 °C</li> <li>Temperature max. (T<sub>smax</sub>) 150 °C</li> <li>Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>s</sub>) 60-120 seconds</li> </ul>	<ul style="list-style-type: none"> <li>150 °C</li> <li>200 °C</li> <li>60-120 seconds</li> </ul>
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T <sub>L</sub> )	183 °C	217 °C
Time at liquidous (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak package body temperature (T <sub>p</sub> )*	Table 1	Table 2
Time (t <sub>p</sub> )** within 5 °C of the specified classification temperature (T <sub>c</sub> )	20 seconds**	30 seconds**
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to Peak temperature	6 minutes max.	8 minutes max.

\* Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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